TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC240AP, TC74HC240AF, TC74HC241AP TC74HC241AF, TC74HC244AP, TC74HC244AF

Octal Bus Buffer

TC74HC240AP/AF Inverted, 3-State

Outputs

TC74HC241AP/AF Non-Inverted,

3-State Outputs

TC74HC244AP/AF Non-Inverted,

3-State Outputs

The TC74HC240A, 241A and 244A are high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate $\rm C^2MOS$ technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

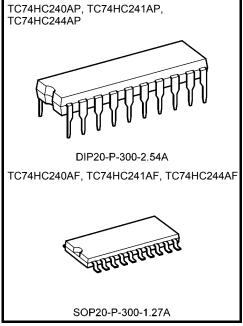
The 74HC240A is an inverting 3-state buffer having two active-low output enables. The TC74HC241A and TC74HC244A are non-inverting 3-state buffers that differ only in that the 241A has one active-high and one active-low output enable, and the 244A has two active-low output enables.

These devices are designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: $t_{pd} = 10 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 6 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS240/241/244

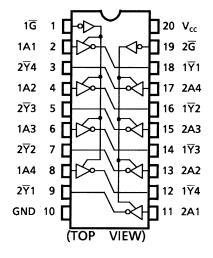


Weight

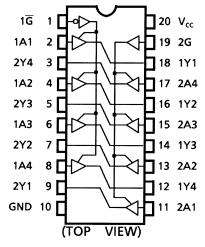
DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

Pin Assignment

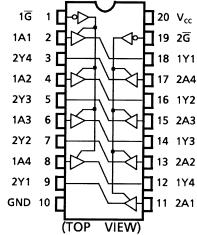
TC74HC240A



TC74HC241A

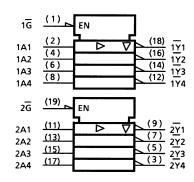


TC74HC244A

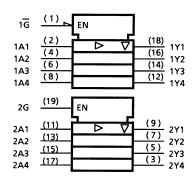


IEC Logic Symbol

TC74HC240A

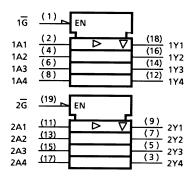


TC74HC241A



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TC74HC244A



Truth Table

	Inputs	Outputs			
G	G∆	An	Yn	\overline{Y}_n $^{\Delta\Delta}$	
L	Н	L	L	Н	
L	Н	Н	Н	L	
Н	L	Х	Z	Z	

 Δ : For TC74HC241A only

 $\Delta\Delta$: For TC74HC240A only

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	−0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V _{CC} /ground current	Icc	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	٧
Operating temperature	T _{opr}	−40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



Electrical Characteristics

DC Characteristics

Characteristics	Symbol		Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
		V _{CC}		V _{CC} (V)	Min	Тур.	Max	Min	Max	
		_		2.0	1.50	_	_	1.50	_	
High-level input voltage	V_{IH}			4.5	3.15	_	_	3.15		V
J				6.0	4.20	_	_	4.20		
		_		2.0	_	_	0.50	_	0.50	
Low-level input voltage	V_{IL}			4.5	_	_	1.35	_	1.35	V
-				6.0	_	_	1.80	_	1.80	
	Voн			2.0	1.9	2.0	_	1.9	_	
		V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
	VoL	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0	_	0.0	0.1	_	0.1	V
				4.5	_	0.0	0.1	_	0.1	
Low-level output voltage				6.0		0.0	0.1	_	0.1	
J			I _{OL} = 6 mA	4.5	_	0.17	0.26	_	0.33	
			I _{OL} = 7.8 mA	6.0	_	0.18	0.26	_	0.33	
3-state output off-state current	I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		6.0	_	_	±0.5	_	±5.0	μА
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_		±0.1	_	±1.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		6.0	_	_	4.0	_	40.0	μА



AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
			CL (pF)	V _{CC} (V)	Min	Тур.	Max	Min	Max	
	t		50	2.0	_	25	60	_	75	ns
Output transition time	t _{TLH}	_		4.5	_	7	12	_	15	
	t _{THL}			6.0	—	6	10	_	13	
				2.0	_	36	90	_	115	
			50	4.5	_	12	18	_	23	
Propagation delay	t_{pLH}			6.0	—	10	15	_	20	ns
time	t_{pHL}	_		2.0	_	51	130	_	165	115
			150	4.5	_	17	26	_	33	
				6.0	—	14	22	_	28	
	^t pZL ^t pZH	$R_L = 1 \text{ k}\Omega$	50	2.0	_	48	125	_	155	- ns
				4.5	_	16	25	_	31	
Output enable time				6.0	_	14	21	_	26	
Output enable time			150	2.0	_	63	165	_	205	
				4.5	_	21	33	_	41	
				6.0	_	18	28	_	35	
	t _{pLZ} t _{pHZ}	$R_L = 1 k\Omega$	50	2.0	_	32	125	_	155	
Output disable time				4.5	_	15	25	_	31	ns
				6.0	_	14	21	_	26	
Input capacitance	C _{IN}	_			_	5	10	_	10	pF
Output capacitance	C _{OUT}	_	_		_	10	_	_	_	pF
Power dissipation capacitance	C _{PD} (Note)	TC74HC240A TC74HC241A/244A			_	31	_	_	_	nE
					_	33	_	_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

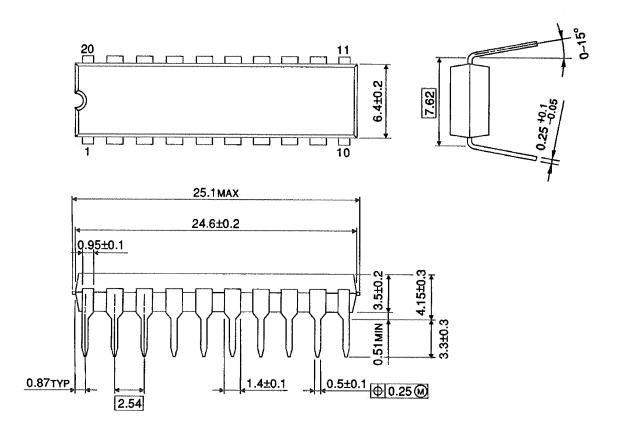
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Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$ (per bit)

Package Dimensions

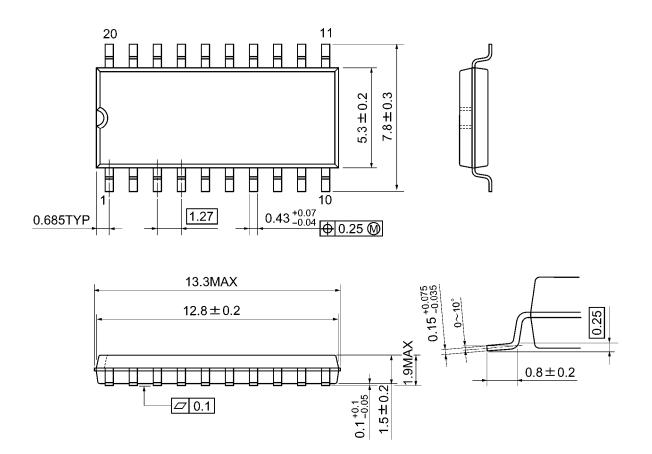
DIP20-P-300-2.54A Unit: mm



Weight: 1.30 g (typ.)

Package Dimensions

SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

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